



REFERENCE SPECIFICATION

Customer:		
Item:	CRYSTAL UNIT	_
Туре:	NX3215SA	_
Nominal Frequency:	32.768kHz	For your reference we submit this specification.
Customer's Spec. No.:		Please study and keep in your related document file.
NDK Spec. No.:	EXS00A-MU00746	_
Charge:		
Sales		
Engineer		
	Revision Recor	d

Contents

Approved

S.Sunaba

Checked

S.Kawanishi

Drawn

Y.Hasuike

Items

Issue

Rev.

Date

17.Jun.2015

1. Customer's Spec. No. : ---

2. NDK Spec. No. : EXS00A-MU00746

3. Type : NX3215SA

4. Electrical Specifications

	Parameters	SYM.		Electri	cal Sp	ec.	Notes
	Farameters	STIVI.	MIN	TYP	MAX	UNITS	Notes
4.1	Nominal Frequency	F_{nom}		32.768	l	kHz	-
4.2	Oscillation Mode	-	Fu	ndame	ntal	-	-
4.3	Load Capacitance	CL		7.0		pF	Network Analyzer (CNA-LF made in Transat corp.)
4.4	Frequency Tolerance	1		+/-20		ppm	at +25 +/-3°C ,Not include aging
4.5	Turning Point	1	-	+25 +/-	5	°C	-
4.6	Temperature coefficient	ı	1	-	-0.04	ppm/ °C²	-
4.7	Operating Temperature range	ı	-40	~	+85	°C	-
4.8	Aging	ı		+/-3		ppm	1 st year (at +25°C)
4.9	Drive level	DL	-	0.1	1.0	uW	-
4.10	Equivalent Resistance	R_{r}	ı	-	70	kΩ	Network Analyzer (CNA-LF made in Transat corp.)
4.11	Shunt Capacitance	C_0	0.5	1.0	1.5	pF	-
4.12	Insulation Resistance	-	500	-	-		Terminal to terminal insulation resistance must be $500M\Omega$ (Min.) when DC100V $\pm 15V$ is applied.
4.13	Storage Temperature range	ı	-40	~	+85	°C	-
4.14	Motional Capacitance	C ₁	2.0	4.0	6.0	fF	Network Analyzer (CNA-LF made in Transat corp.)

5. Examination results document

Since a performance is guaranteed, an examination results document does not submit.

6. Application drawing

6.1 Dimension drawing : EXD14B-00462 6.2 Taping and reel figure : EXK17B-00303 6.3 Holder marking : EXH11B-00422 6.4 Reel Packing : EEK17B-00015 6.5 Reliability assurance Item : EXS30B-00952

7. Notice

- 7.1 Order items are manufactured according to specification. As to conditions, which are not indicated in this specification and unpredictable such as applied condition and oscillation margin, please check them beforehand.
- 7.2 Unless we receive request for modification within 3 weeks from the issue date of this NDK specification sheet, we will supply products according to this specification. Also, if you'd like to modify specification of order, which has been placed with delivery request within 3 weeks from the issue data of this specification sheet, we would like to discuss with you separately.
- 7.3 In no event shall the company be liable for any product failure resulting from an inappropriate handling or operation of the product beyond the scope of its guarantee.
- 7.4 Where any change to the process condition is made due to the change(s) in the production line, inform personnel of the specifications.
- 7.5 Should this specification data give rise to any disputes relating to any intellectual property rights or any other rights of a third person, the company shall not indemnify anyone for any damage. Their disclosure must not be construed as the grant of a license to use any of the intellectual property rights owned by the company.
- 7.6 If you intend to use products listed on this specification for applications that may result in loss of life or assets (controls relating to safety, medical equipment, aeronautical equipment, space equipment, etc.), please do not fail to advise us of your intention beforehand.
- 7.7 In the company's production process whatever amount of ozone depleting substances (ODS) as specified in the Montreal protocol is not used.
- 7.8 Information contained in this specification must not be quoted, reproduced or used for other purposes including processing either in part or in full without obtaining prior approval from the company.
- 7.9 The appearance color and so on have a different case by purchasing it more than 2 suppliers of the component, but characteristic and reliability are guaranteed.
- 7.10 Crystal units will be damaged by ultrasonic welding process due to resonance of crystal wafer itself. NDK does not recommend using ultrasonic welding. If Ultra Sonic welding used, NDK strongly recommend verifying crystal unit damage by ultrasonic weld.

8. Prohibited items

Be sure to use the product under the following conditions. Otherwise, the characteristics deterioration or destruction of the product may result.

(1)Reflow soldering heat resistance

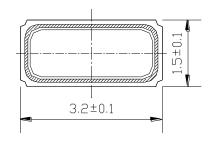
Peak temperature : 265°C, 10 sec

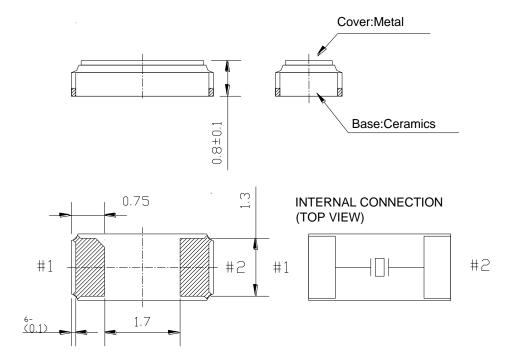
Heating : 230°C or higher, 30 sec Preheating : 150°C to 180°C, 120 sec

Reflow passage times: twice

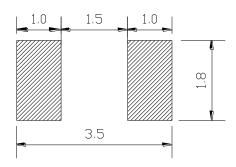
(2)Manual soldering heat resistance

Pressing a soldering iron of 400°C on the terminal electrode for four seconds (twice).



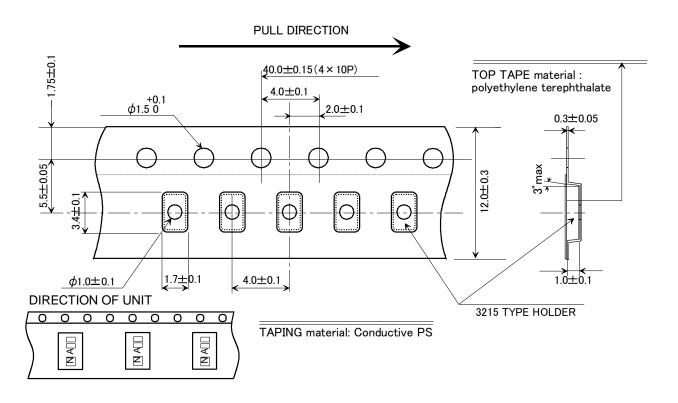


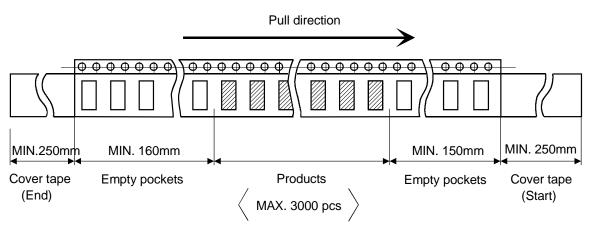
Recommended soldering pattern



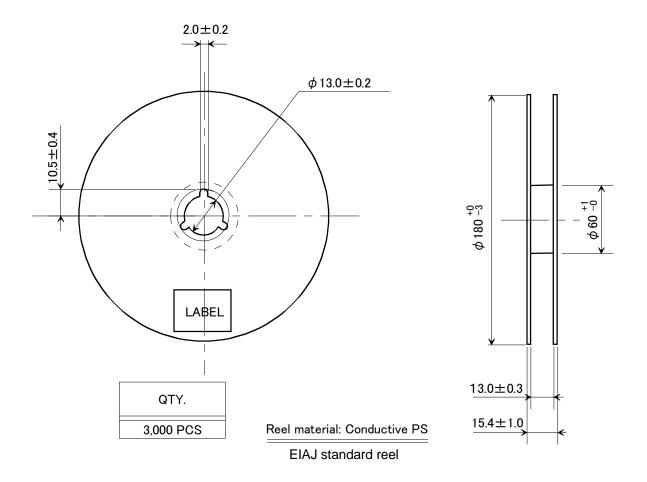
	Da	te of Revise	Charge	Approved	Reason			
В	10.May	.2012	Hasuike	Matsudo	Add biling	jual		
		Date	Name	Third Angle Proj	ection	Tolerance	Sc	ale
Dra	wn	30.Aug.2009	Miyahara	Dimension:r	nm	±0.2	10	/ 1
Des	signed	30.Aug.2009	Miyahara	Title		Drawing No.		Rev.
Che	ecked			NX321	5SA	EVD44B	00460	0
App	roved	30.Aug.2009	K. Ueki	External Di	mensior	n EXD14B-	·UU40Z	В

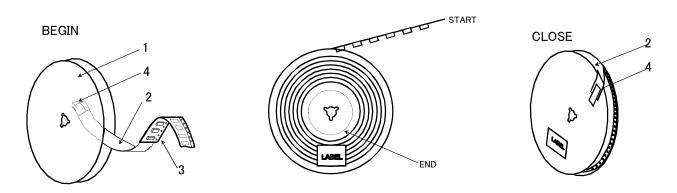
NIHON DEMPA KOGYO CO., LTD.



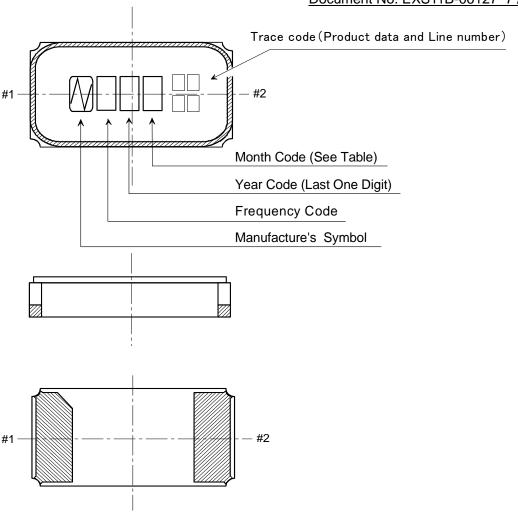


	Da	te of Revise	Charge	Approved	Reason				
В	24.Apr.2	2013	Sato	Matsudo	Added Eng	glish			
		Date	Name	Third Angle Projection		Tolerance	Sca	le	
Dra	wn	9.Jul.2009	N.Yamamoto	mm	mm			/	
Des	signed	9.Jul.2009	N.Yamamoto	Title			Drawing No.		Rev.
Che	ecked			0045 TVDE T '			EXK17B-0	02024/2	1
App	roved	9.Jul.2009	K.Ueki	3215 TYPE Taping	and Reel Spec.		EXK1/B-0	0303 1/2	В





	Dat	te of Revise	Charge	Approved	Reason			
В	24.Apr.2	2013	Sato	Matsudo	Added Eng	lish		
		Date	Name	Third Angle Projection		Tolerance	Scale	
Drav	wn	9.Jul.2009	N.Yamamoto	mm			/	
Desi	igned	9.Jul.2009	N.Yamamoto	Title		Drawing No.		Rev.
Che	cked			2045 TVDE Tanina	and Daal Car	EVV17D 0	0202 2/2	J
Appr	roved	9.Jul.2009	K.Ueki	3215 TYPE Taping	and Keel Spe	ec. EXK17B-0	U3U3 ZIZ	В



NOTE

1. Month Code

Month	1	2	3	4	5	6	7	8	9	10	11	12
	Jan.	Feb.	Mar.	Apr.	May	June	July	Aug.	Sep.	Oct.	Nov.	Dec.
Month Code	1	2	3	4	5	6	7	8	9	Х	Y	Z

2. Frequency Code

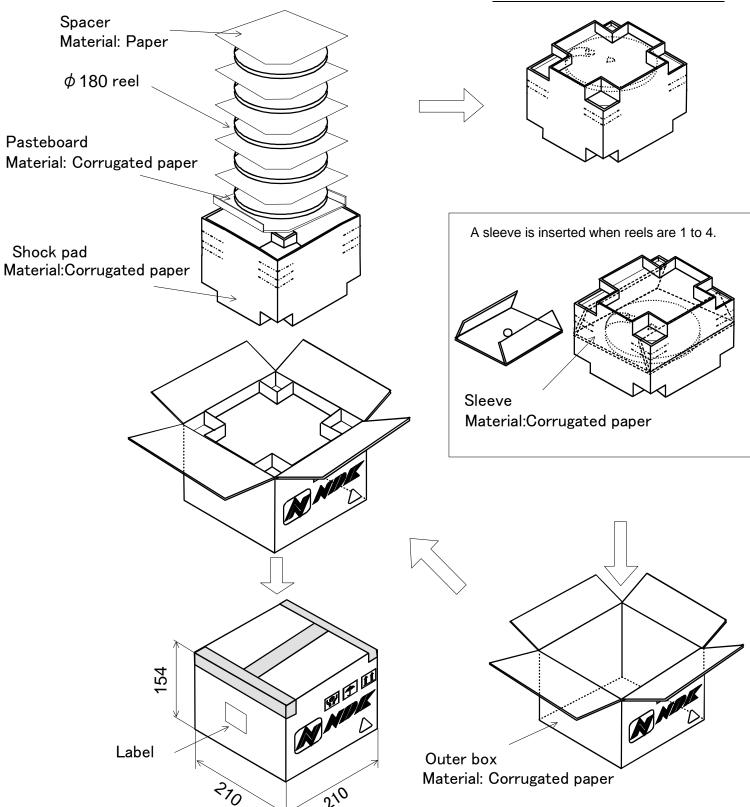
A: 32.768kHz

3. Marking Method

Marking Method is Laser Triming.

	Date of Revise	Charge	Approved	Reason			
	Date	Name	Name Third Angle Projection		Tolerance	Sc	ale
Drawn	28.OCt.2009	Miyahara	Dimension:mr	Dimension:mm		,	/
Designe	d 28.OCt.2009	Miyahara	Title		Drawing No.		Rev.
Checked			NX321	5SA	EVIJAAD	00400	
Approve	d 28.OCt.2009	Ueki	Marking D	rawing	EXH11B-	-00422	

Document No. EXS11B-06127 8 / 10



	Dat	e of Revise	Charge	Approved	Reaso	n			
С	4	Jul. 2012	H.Ohkubo	K.Oguri	i Addition of condition when re-		reels are 1	to 4.	
		Date	Name	Third Angle Proje	Angle Projection To		Tolerance S		ale
Drav	wn	26 Feb. 2010	H. Ohkubo	Dimension:mi	m	1			
Des	signed	26 Feb. 2010	K.Oguri	Title			Drawing No.		Rev.
Che	ecked	26 Feb. 2010	K.Oguri	180 dia. Ree	l pook	2000	EEK17B-	00015)
App	roved	26 Feb. 2010	J. Nakamura	100 ula. Ree	i pack	aye	EEKI/B.	-00013	С

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Reliability assurance item

(page: 1/2)

No.	Test Item	Test Methods	Specification Code
1	AGING	1 year at 25 °C +/- 3°C	А
2	HEAT RESISTANCE	at 85 °C for 500 hours.	В
3	COLD RESISTANCE	at –40 °C for 500 hours.	В
4	HUMIDITY	at +85 °C with 80 to 85 % RH for 500 hours.	В
5	THERMAL SHOCK	Temperature cycle as shown in (Fig.1) for 100 cycle. +85±3°C -40±3°C ONE CYCLE (Fig.1)	В
6	VIBRATION	Frequency Range : 10 to 2000Hz Amplitude or Acceleration : 1.52 mm or 20 G 1 cycle : 20 minutes Test time : Three mutually perpendicular axes each 12 times.	В
7	SHOCK 1	Shock : 3000 Gs 0.3 msec. Test time : Six mutually perpendicular axes each 1 times.	В
8	SHOCK 2	Shock : Device are put on the weight of 200 g and dropped on concrete board. Height : 1.5 m Drop times : Six mutually perpendicular axes each 10 times.	С
9	SOLDERABILITY	Residual heat temperature: 150 °C Residual heat time: 60 to 120 sec Peak temperature: 240 °C (more than 215 °C 10 to 30 sec)	D
10	REFLOW RESISTANCE	Temperature cycle as shown in (Fig2.) for 3 cycle.	В

Specification code	Specification
A	dF/F ≤ +/- 3ppm
В	$dF/F \le +/-5ppm$ $dCI \le +/-5 kohm$
С	dF/F ≤ +/- 15ppm dCl ≤ +/- 5 kohm
D	The electrodes shall acquire a new solder coat over at least 90 % of immersed area.

(page: 2/2)

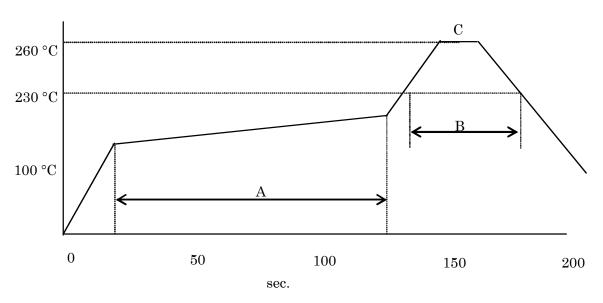


Fig.2 REFLOW

A: 150 to 180 °C (60 to 120 sec.)

B: 230 °C min. (30 sec. max.)

C: PEAK-TEMP. 260 °C +/- 5 °C (10sec. max.)